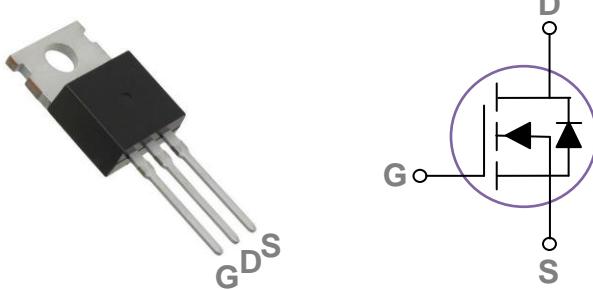


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO220 Pin Configuration



| BVDSS | RDS(ON) | ID  |
|-------|---------|-----|
| 100V  | 18mΩ    | 60A |

### Features

- 100V,60A, RDS(ON) =18mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Networking
- Load Switch
- LED applications

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol    | Parameter  | Rating     | Units               |
|-----------|--|------------|---------------------|
| $V_{DS}$  | Drain-Source Voltage                                   | 100        | V                   |
| $V_{GS}$  | Gate-Source Voltage                                    | $\pm 20$   | V                   |
| $I_D$     | Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )  | 60         | A                   |
|           | Drain Current – Continuous ( $T_c=100^\circ\text{C}$ ) | 38         | A                   |
| $I_{DM}$  | Drain Current – Pulsed <sup>1</sup>                    | 180        | A                   |
| EAS       | Single Pulse Avalanche Energy <sup>2</sup>             | 100        | mJ                  |
| IAS       | Single Pulse Avalanche Current <sup>2</sup>            | 45         | A                   |
| $P_D$     | Power Dissipation ( $T_c=25^\circ\text{C}$ )           | 113        | W                   |
|           | Power Dissipation – Derate above $25^\circ\text{C}$    | 0.9        | W/ $^\circ\text{C}$ |
| $T_{STG}$ | Storage Temperature Range                              | -50 to 150 | $^\circ\text{C}$    |
| $T_J$     | Operating Junction Temperature Range                   | -50 to 150 | $^\circ\text{C}$    |

### Thermal Characteristics

| Symbol          | Parameter                              | Typ. | Max. | Unit               |
|-----------------|--|------|------|--------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | ---  | 62   | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case    | ---  | 1.1  | $^\circ\text{C/W}$ |



100V N-Channel MOSFETs

PDP0966A

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)****Off Characteristics**

| Symbol                                     | Parameter  | Conditions   | Min. | Typ. | Max.      | Unit                      |
|--|--|--|------|------|-----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                   | $V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$                                 | 100  | ---  | ---       | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | $\text{BV}_{\text{DSS}}$ Temperature Coefficient | Reference to $25^\circ\text{C}$ , $I_D=1\text{mA}$                               | ---  | 0.05 | ---       | $\text{V}/^\circ\text{C}$ |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current                     | $V_{\text{DS}}=100\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$ | ---  | ---  | 1         | $\mu\text{A}$             |
|  |  | $V_{\text{DS}}=80\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$ | ---  | ---  | 10        | $\mu\text{A}$             |
| $I_{\text{GSS}}$                           | Gate-Source Leakage Current                      | $V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$                       | ---  | ---  | $\pm 100$ | nA                        |

**On Characteristics**

|                     |                                   |  |     |     |     |                            |
|---------------------|-----------------------------------|--|-----|-----|-----|----------------------------|
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{\text{GS}}=10\text{V}$ , $I_D=25\text{A}$          | --- | 15  | 18  | $\text{m}\Omega$           |
|                     |                                   | $V_{\text{GS}}=6\text{V}$ , $I_D=15\text{A}$           | --- | 20  | 28  | $\text{m}\Omega$           |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage            | $V_{\text{GS}}=V_{\text{DS}}$ , $I_D = 250\mu\text{A}$ | 2   | --- | 4   | V                          |
|                     |                                   |  | --- | -5  | --- | $\text{mV}/^\circ\text{C}$ |
| $g_{\text{fs}}$     | Forward Transconductance          | $V_{\text{DS}}=10\text{V}$ , $I_D=3\text{A}$           | --- | 10  | --- | S                          |

**Dynamic and switching Characteristics**

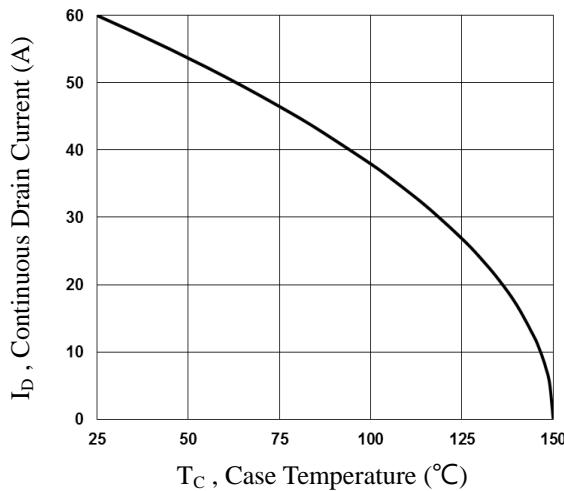
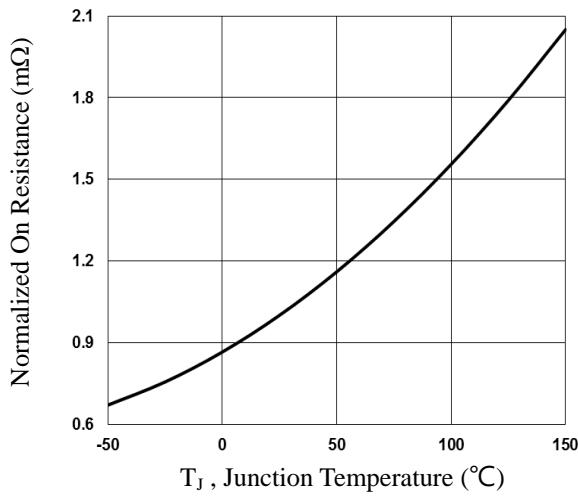
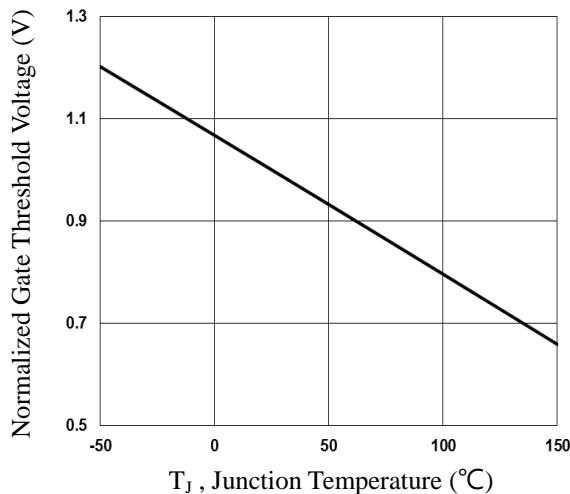
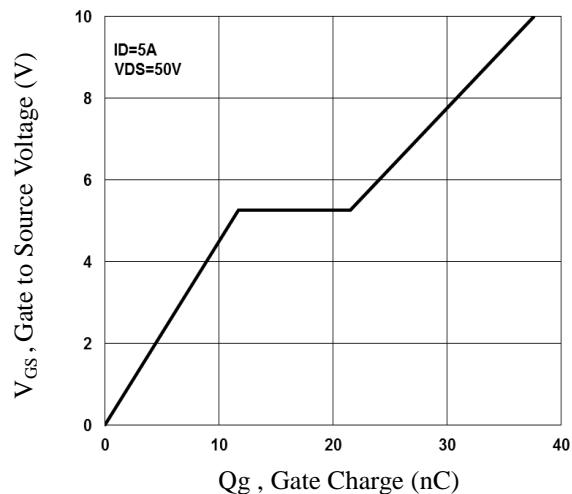
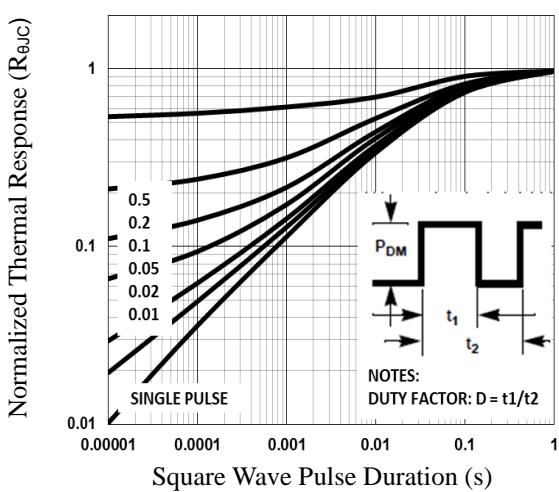
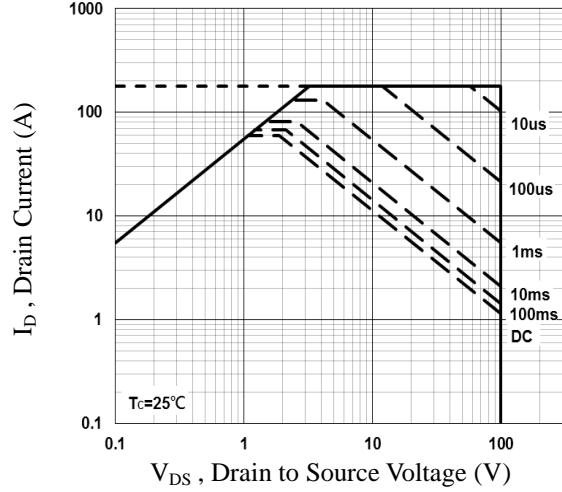
|                     |                                     |  |     |      |      |          |
|---------------------|-------------------------------------|--|-----|------|------|----------|
| $Q_g$               | Total Gate Charge <sup>3, 4</sup>   | $V_{\text{DS}}=50\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=5\text{A}$                  | --- | 37.6 | 70   | nC       |
| $Q_{\text{gs}}$     | Gate-Source Charge <sup>3, 4</sup>  |  | --- | 11.7 | 22   |          |
| $Q_{\text{gd}}$     | Gate-Drain Charge <sup>3, 4</sup>   |  | --- | 9.8  | 19   |          |
| $T_{\text{d(on)}}$  | Turn-On Delay Time <sup>3, 4</sup>  | $V_{\text{DD}}=50\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=6\Omega$<br>$I_D=1\text{A}$ | --- | 20   | 40   | ns       |
| $T_r$               | Rise Time <sup>3, 4</sup>           |  | --- | 15   | 30   |          |
| $T_{\text{d(off)}}$ | Turn-Off Delay Time <sup>3, 4</sup> |  | --- | 45   | 80   |          |
| $T_f$               | Fall Time <sup>3, 4</sup>           |  | --- | 21   | 40   |          |
| $C_{\text{iss}}$    | Input Capacitance                   | $V_{\text{DS}}=50\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$                   | --- | 1850 | 3300 | pF       |
| $C_{\text{oss}}$    | Output Capacitance                  |  | --- | 160  | 300  |          |
| $C_{\text{rss}}$    | Reverse Transfer Capacitance        |  | --- | 85   | 160  |          |
| $R_g$               | Gate resistance                     | $V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$                    | --- | 1.35 | 2.6  | $\Omega$ |

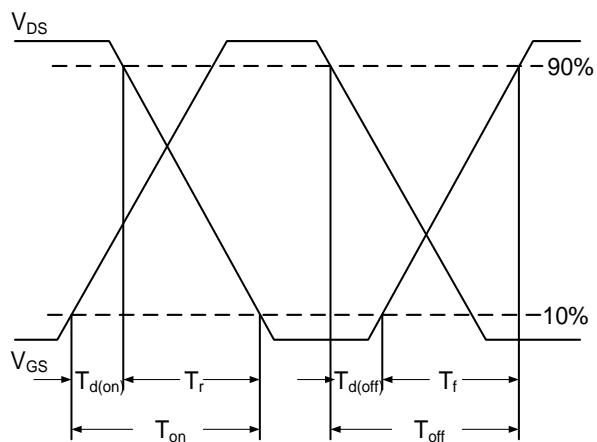
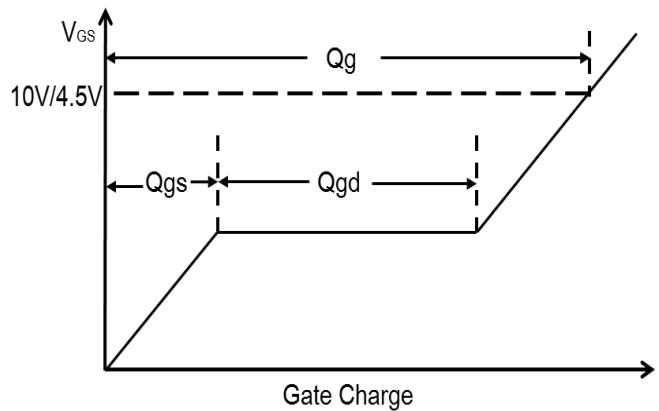
**Drain-Source Diode Characteristics and Maximum Ratings**

| Symbol          | Parameter                            | Conditions   | Min. | Typ. | Max. | Unit |
|-----------------|--------------------------------------|--|------|------|------|------|
| $I_s$           | Continuous Source Current            | $V_G=V_D=0\text{V}$ , Force Current                                      | ---  | ---  | 60   | A    |
|                 |                                      |  | ---  | ---  | 120  | A    |
| $V_{\text{SD}}$ | Diode Forward Voltage                | $V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$     | ---  | ---  | 1    | V    |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>3</sup>   | $I_s=1\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ $T_J=25^\circ\text{C}$ | ---  | ---  | ---  | ns   |
| $Q_{\text{rr}}$ | Reverse Recovery Charge <sup>3</sup> |  | ---  | ---  | ---  | nC   |

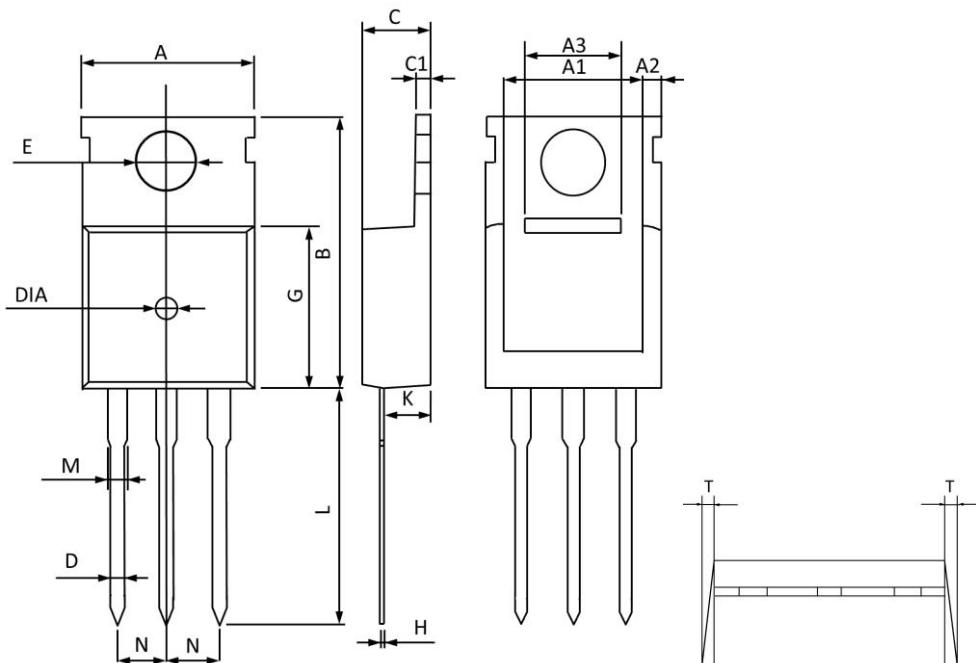
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=45\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed, pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs.  $T_C$** 

**Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$** 

**Fig.3 Normalized  $V_{th}$  vs.  $T_J$** 

**Fig.4 Gate Charge Characteristics**

**Fig.5 Normalized Transient Impedance**

**Fig.6 Maximum Safe Operation Area**


**Fig.7 Switching Time Waveform**

**Fig.8 Gate Charge Waveform**

## TO220 PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters |              | Dimensions In Inches |                |
|--------|---------------------------|--------------|----------------------|----------------|
|        | MAX                       | MIN          | MAX                  | MIN            |
| A      | 10.300                    | 9.700        | 0.406                | 0.382          |
| A1     | 8.840                     | 8.440        | 0.348                | 0.332          |
| A2     | 1.250                     | 1.050        | 0.049                | 0.041          |
| A3     | 5.300                     | 5.100        | 0.209                | 0.201          |
| B      | 16.200                    | 15.400       | 0.638                | 0.606          |
| C      | 4.680                     | 4.280        | 0.184                | 0.169          |
| C1     | 1.500                     | 1.100        | 0.059                | 0.043          |
| D      | 1.000                     | 0.600        | 0.039                | 0.024          |
| E      | 3.800                     | 3.400        | 0.150                | 0.134          |
| G      | 9.300                     | 8.700        | 0.366                | 0.343          |
| H      | 0.600                     | 0.400        | 0.024                | 0.016          |
| K      | 2.700                     | 2.100        | 0.106                | 0.083          |
| L      | 13.600                    | 12.800       | 0.535                | 0.504          |
| M      | 1.500                     | 1.100        | 0.059                | 0.043          |
| N      | 2.590                     | 2.490        | 0.102                | 0.098          |
| T      | W0.35                     |              | W0.014               |                |
| DIA    | Φ1.5 TYP.                 | deep0.2 TYP. | Φ0.059 TYP.          | deep0.008 TYP. |